


**PRODUCT / PROCESS CHANGE INFORMATION**

**1. PCI basic data**

<b>1.1 Company</b>		STMicroelectronics International N.V
<b>1.2 PCI No.</b>	CRP/22/13304	
<b>1.3 Title of PCI</b>	Notification related to 2nd EMEA DC project in Frankfurt	
<b>1.4 Product Category</b>	Notification related to MDG FG products list	
<b>1.5 Issue date</b>	2022-04-14	

**2. PCI Team**

<b>2.1 Contact supplier</b>	
<b>2.1.1 Name</b>	KLEINSCHMIDT TOBIAS
<b>2.1.2 Phone</b>	+49 89460062121
<b>2.1.3 Email</b>	tobias.kleinschmidt@st.com
<b>2.2 Change responsibility</b>	
<b>2.2.1 Process Owner</b>	Mohamed ALAOUI ISMAILI
<b>2.1.2 Corporate Quality Manager</b>	Gerard PETIT

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
General (Logistic)	New location (hub, warehouse)	NA

**4. Description of change**

	Old	New
<b>4.1 Description</b>	<p>Setup of a 2nd EMEA DC in Frankfurt for closer deliveries to customers in Germany &amp; Eastern Europe. The change also includes personnel, location, logistic model.</p> <p>Current condition: No existence of a 2nd Distribution Center in Europe.</p>	<p>LSP: GEODIS Logistics. Operations:</p> <ul style="list-style-type: none"> <li>- Importation: Brokerage service</li> <li>- Airport handling, cartage and Inbound processing</li> <li>- Inventory management: staging, repacking..</li> <li>- Pick from staging, outbound and shipments execution</li> <li>- Customer delivery</li> <li>- Customer return</li> </ul> <p>Finance</p> <ul style="list-style-type: none"> <li>- DC set up, finance flows</li> <li>- VAT</li> <li>- Intrast</li> <li>- Trade compliance</li> </ul> <p>Location: Frankfurt</p> <p>Working areas Temperature, Humidity and Lux calibrated according to ST Logistics standards.</p>
<b>4.2 Anticipated Impact on form, fit, function, quality, reliability or processability?</b>	<p>Form: No change on product</p> <ul style="list-style-type: none"> <li>- Fit: No change on product</li> <li>- Function: No change on product</li> <li>- Reliability, or Processability: NA (Not applicable).</li> </ul>	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	Enhanced Broker Services. Operational improvements and services. Closer deliveries to external customers in Germany and Eastern Europe.
<b>5.2 Customer Benefit</b>	SERVICE IMPROVEMENT

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	NA
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2022-05-06
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7.2 Intended start of delivery	2022-05-08
7.3 Qualification sample available?	Upon Request

**8. Qualification / Validation**

8.1 Description			
8.2 Qualification report and qualification results	In progress	Issue Date	

**9. Attachments (additional documentations)**

13304 Public product.pdf  
13304 PCI\_change\_Frankfurt\_2nd\_EMEA\_DC\_v3.pdf

**10. Affected parts**

10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	B-U585I-IOT02A	
	KERKEY-ER2OR1	
	KERKEY-GEN2-LDG	
	M24128-BFMC6TG	
	M24128-BFMN6TP	
	M24128-BRMN6P	
	M24128-BRMN6TP	
	M24128-BWMN6P	
	M24128-BWMN6TP	
	M24256-BFMC6TG	
	M24256-BRDW6TP	
	M24256-BRMN6P	
	M24256-BRMN6TP	
	M24256-BWDW6TP	
	M24256-BWMN6P	
	M24256-BWMN6TP	
	M24512-DFMC6TG	
	M24512-RDW6TP	
	M24512-RMN6P	
	M24512-RMN6TP	
	M24512-WDW6TP	
	M24512-WMN6P	
	M24512-WMN6TP	
	M24C01-RMN6TP	
	M24C01-WMN6P	
	M24C01-WMN6TP	
	M24C02-RDW6TP	
	M24C02-RMC6TG	
	M24C02-RMN6P	
	M24C02-RMN6TP	
	M24C02-WDW6TP	
	M24C02-WMN6P	
	M24C02-WMN6TP	
	M24C04-RMN6TP	
	M24C04-WDW6TP	
	M24C04-WMN6P	
	M24C04-WMN6TP	

	M24C08-RDW6TP	
	M24C08-RMC6TG	
	M24C08-WMN6P	
	M24C08-WMN6TP	
	M24C16-RMN6P	
	M24C16-RMN6TP	
	M24C16-WDW6TP	
	M24C16-WMN6P	
	M24C16-WMN6TP	
	M24C32-FMC6TG	
	M24C32-FMC6TG/T	
	M24C32-FMN6TP	
	M24C32-RDW6TP	
	M24C32-RMN6P	
	M24C32-RMN6TP	
	M24C32-WDW6TP	
	M24C32-WMN6P	
	M24C32-WMN6TP	
	M24C64-FMC6TG	
	M24C64-FMN6TP	
	M24C64-RDW6TP	
	M24C64-RMN6P	
	M24C64-RMN6TP	
	M24C64-WDW6TP	
	M24C64-WMN6P	
	M24C64-WMN6TP	
	M24LR04D-WDW8T/2	
	M24M01-DFDW6TP	
	M24M01-RDW6TP	
	M24M01-RMN6P	
	M24M01-RMN6TP	
	M93C46-WDW6TP	
	M93C46-WMN6P	
	M93C46-WMN6TP	
	M93C56-WMN6P	
	M93C56-WMN6TP	
	M93C66-WDW6TP	
	M93C66-WMN6P	
	M93C66-WMN6TP	
	M93C86-WMN6P	
	M93C86-WMN6TP	
	M93S46-WMN6TP	
	M93S56-WMN6P	
	M93S56-WMN6TP	
	M93S66-WMN6TP	
	M95010-WDW6TP	
	M95010-WMN6P	
	M95010-WMN6TP	
	M95020-WMN6P	
	M95020-WMN6TP	
	M95040-RDW6TP	

	M95040-WDW6TP	
	M95040-WMN6P	
	M95040-WMN6TP	
	M95080-RDW6TP	
	M95080-RMC6TG	
	M95080-WDW6TP	
	M95080-WMN6P	
	M95080-WMN6TP	
	M95128-RDW6TP	
	M95128-RMN6TP	
	M95128-WMN6P	
	M95128-WMN6TP	
	M95160-RDW6TP	
	M95160-WDW6TP	
	M95160-WMN6P	
	M95160-WMN6TP	
	M95256-RDW6TP	
	M95256-RMN6TP	
	M95256-WDW6TP	
	M95256-WMN6P	
	M95256-WMN6TP	
	M95320-WMN6P	
	M95320-WMN6TP	
	M95512-DFMC6TG	
	M95512-RDW6TP	
	M95512-RMN6TP	
	M95512-WDW6TP	
	M95512-WMN6P	
	M95512-WMN6TP	
	M95640-DFCT6TP/K	
	M95640-RDW6TP	
	M95640-RMC6TG	
	M95640-WDW6TP	
	M95640-WMN6P	
	M95640-WMN6TP	
	M95M01-RDW6TP	
	M95M01-RMN6P	
	M95M01-RMN6TP	
	M95M02-DRMN6TP	
	NUCLEO-WL55JC2	
	SPEAR320S-2	
	ST33HTPH2X32AHD4	
	STID135-WB	
	STM32F030CCT6TR	
	STM32F030K6T6TR	
	STM32F051C8T6TR	
	STM32F051C8T7TR	
	STM32F051K8U6	
	STM32F070CBT6TR	
	STM32F071CBT6TR	
	STM32F091CCT6TR	

	STM32F100C8T6B	
	STM32F100VBT6BTR	
	STM32F100VCT6BTR	
	STM32F103VGT6TR	
	STM32F207VCT6	
	STM32F301VCT6TR	
	STM32F303RBT7	
	STM32F303ZET6	
	STM32F401C8U6	
	STM32F401RET6TR	
	STM32F405VGT6TR	
	STM32F412RGT6TR	
	STM32F415RGT6TR	
	STM32F427IIH6TR	
	STM32F427VIT7TR	
	STM32F427ZIT7TR	
	STM32F429IIH6TR	
	STM32F429ZGT6	
	STM32G071CBT6TR	
	STM32G071GBU6	
	STM32G071KBU6TR	
	STM32G0B1RCI6NTR	
	STM32G471RCT6	
	STM32G473VET6TR	
	STM32H743BIT6	
	STM32L151C8T6	
	STM32L151CCT6	
	STM32L412C8T6	
	STM32L412CBT6TR	
	STM32L475RGT6	
	STM32L486RGT6TR	
	STM32L4R5VIT6	
	STM32P301VCMCOTR	
	STM32WB55VDIE0	
	STM8L101F3U6TR	
	STM8L151F3P6TR	
	STM8L151F3U6TR	
	STM8LP151K4LIZTR	
	STM8S105K6U6ATR	
	STSAFA100DFSDR01	
	STSAFA100S8TLN01	
	STSAFA110DFALF01	
	STSAFA110DFMLX01	
	STSAFA110S8SFM01	

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